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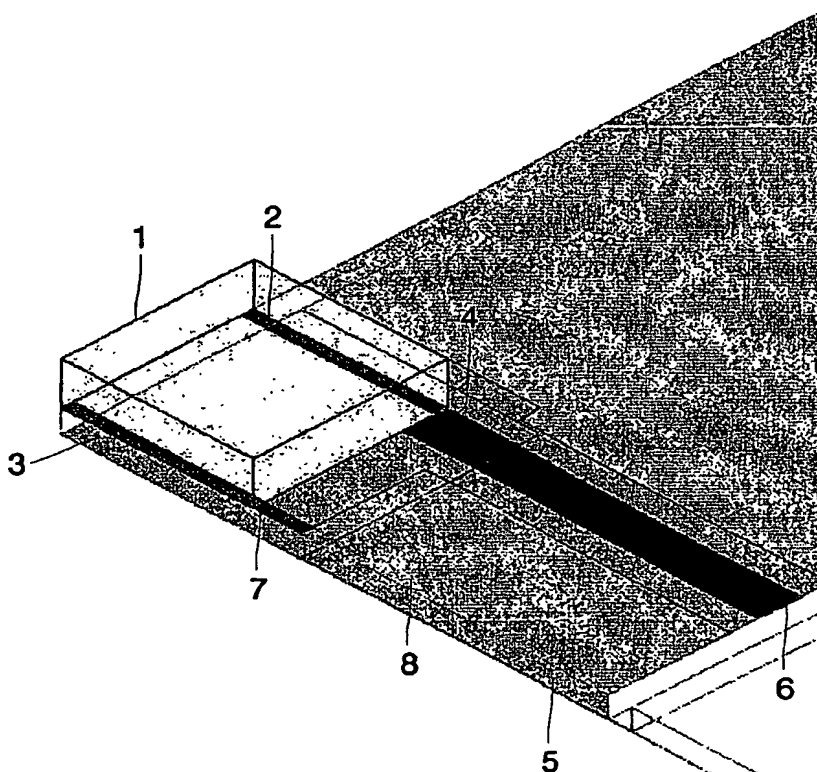
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(54) Title: MINIATURIZED MULTIBAND ANTENNA



(57) Abstract: The invention relates to an antenna comprising a dielectric substrate (1) and two resonant printed wiring structures, more particularly for use in high-frequency and microwave domain. On an end face of the substrate (1) a first printed wiring structure (2) is arranged along a first edge and on an opposite, second edge of the same end face a second printed wiring structure (3). The arrangement of the printed wiring structures provides that resonances are developed which make the use of the proposed antennas in the four separate GPS, DCS/PCS, UMTS and Bluetooth applications possible.

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